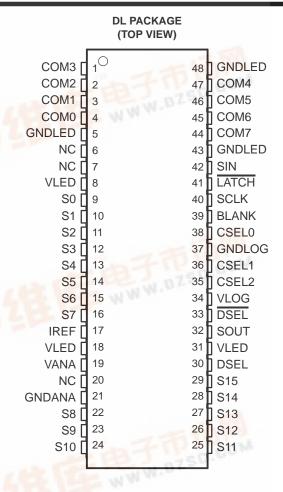


- Segment . . . 30 mA × 16 Bits
- Common . . . 640 mA
- Constant Current Output . . . 3 mA to 30 mA (Current Value Setting for All Channels Using External Resistor)
- Constant Current Accuracy ±6% (Maximum Error Between Bits)
- Data Input: Clock Synchronized Serial Input
- LED Type Applied Cathode Common
- Logic Power Supply Voltage 4.5 V to 5.5 V
- LED Power Supply Voltage 4.5 V to 5.5 V
- Operating Frequency . . . 10 MHz
- Operating Free-Air Temperature Range –20°C to 85°C
- 48-Pin SSOL Package

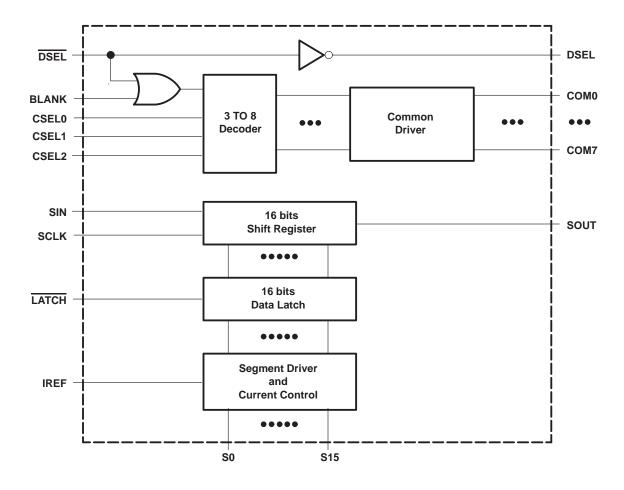
description

The TLC5920 is an LED driver incorporating a 16-channel shift register, data latch, and constant current circuitry with current value control and 8-channel common driver into a single chip. The constant output current is capable of 30 mA for 16 bits simultaneously, and the current value can be set by one external register. This device also includes a 16-bit segment driver and 8-bit common driver; therefore, the monocolor LED array with 16×8 dots can be driven by only one TLC5920, and a two-color LED array with 16×16 dots can be driven by two TLC5920s.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

functional block diagram





Terminal Functions

TERMINAL			DECODINE			
NAME	NO.	I/O	DESCRIPTION			
BLANK	39	I	Blank(light off). By turning all the output for the common driver off, the LED is turned off. When BLANK is high, the LED is turned off.			
COM0 – COM7	4, 3, 2, 1, 47, 46, 45, 44	0	LED common driver output			
CSEL0 – 2	38, 36, 35	I	Common driver select. One terminal out of COM0 through COM7 is selected. 2 1 0 Common Driver L L L 0 L L H 1 L H L 2 L H H 3 H L L 4 H H L 5 H H H 6 H H H 7			
DSEL	33	ı	Display select. When DSEL is high, the LED is turned off. Note that, when BLANK is high, the LED is turned off with no regard to the DSEL input.			
DSEL	30	0	Display select output. The inverted data of DSEL is clocked out.			
GNDANA	21		Analog ground			
GNDLED	5, 43, 48		LED driver ground			
GNDLOG	37		Logic ground			
IREF	17	I	Constant current control setting. The LED current is set to the desired value by connecting an external resistor between IREF and GND.			
LATCH	41	I	Latch. When LATCH is high, data on the shift register goes through latch. When LATCH is low, data is latched.			
SIN	42	ı	Serial input for display			
SOUT	32	0	Serial output for display			
SCLK	40	I	Synchronous clock input for serial data transfer. The input data of SIN is synchronized to the rising edge of SCLK, and transferred to SOUT.			
S0 – S15	9, 10, 11, 12, 13, 14, 15, 16, 22, 23, 24, 25, 26, 27, 28, 29	0	LED segment driver output			
VANA	19		Analog power supply voltage			
VLOG	34		Logic power supply voltage			
VLED	8, 18, 31		LED driver power supply voltage			



TLC5920 16x8 BIT LED DRIVER/CONTROLLER

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absolute maximum ratings† (see Note 1)

Logic supply voltage, V _(LOG)	– 0.3 V to 7 V
LED supply voltage, V _(LED)	– 0.3 V to 7 V
Analog supply voltage, V _(ANA)	
Output current, I _{OH(S)}	
Output current, I _{OL(C)}	650 mA
Input voltage range, V _I	– 0.3 V to $V_{(LOG)}$ + 0.3 V
Output voltage range, V _O	
Continuous total power dissipation	
Thermal resistance	83°C/W
Operating free-air temperature range (see Note 2), T _A	– 20 to 85°C
Storage temperature range, T _{Stq}	–40°C to 125°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

dc characteristics (see Note 3)

PARAMETER	TEST CONDITIONS	MIN	NOM	MAX	UNIT
Logic supply voltage, V(LOG)		4.5	5	5.5	V
LED supply voltage, V _(LED)		4.5	5	5.5	V
Analog power supply, V(ANA)		4.5	5	5.5	V
Voltage between GND and V(DEF), G(DEF)	G(DEF) = GND(LOG) - GND(LED)	-0.3	0	0.3	V
High-level input voltage, V _{IH}		2.0		V _(LOG)	V
Low-level input voltage, V _{IL}		GND _(LOG)		0.8	V
High-level output current, IOH	$V_{(LOG)} = 4.5V$, SOUT, DSEL			-1	mA
High-level output current, IOH(S)	S0 to S15			-30	IIIA
Low-level output current, IOL	$V_{(LOG)} = 4.5V$, SOUT, DSEL			1.6	mA
Low-level output current, IOL(C)	DUTY = 1/16, COM0 to COM7			640	IIIA
Operating free-air temperature range, T _A (see Note 2)		-20		85	°C

NOTES: 2 $T_J \le 150^{\circ}C$ (refer to appendix thermal condition). 3. V_{ANA} must be same as V_{LED} .

ac characteristics ($T_A = -20^{\circ}C$ to $85^{\circ}C$)

	PARAMETER	TEST CONDITIONS	MIN	NOM	MAX	UNIT
f(SCLK)	Shift clock frequency				10	MHz
tw(H)/tw(I)	SCLK pulse duration (high- or low-level)		40			ns
t _r /t _f	Rise/fall time				100	ns
t _{su}	Setup time	SIN - SCLK	10			ns
		SCLK – LATCH	10			
th	Hold time	LATCH - SCLK	10			ns
		SIN - SCLK	10] ''3



NOTES: 1. All voltage values are with respect to GND terminal.

^{2.} $T_J \le 150^{\circ}C$ (refer to appendix thermal condition).

electrical characteristics (unless otherwise noted), MIN/MAX: $V_{(LOG)} = V_{(ANA)} = V_{(LED)} = 4.5 \text{ V to } 5.5 \text{ V}, T_A = -20^{\circ}\text{C to } 85^{\circ}\text{C}$ TYP: $V_{(LOG)} = V_{(ANA)} = V_{(LED)} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$

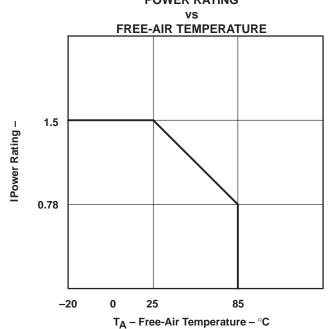
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Vон	High-level output voltage	I _{OH} = -1 mA, SOUT, DSEL	3.6			V
\/01	Low-level output voltage	I _{OL} = 1.6 mA, SOUT, DSEL			0.6	V
VOL		I _{OL} = 640 mA, COM0 to COM7 0.6		0.6	0.9	V
lį	Input current	$V_I = V_{(LOG)}$ or $GND_{(LOG)}$			±1	μΑ
I(LOG)		Data transfer, SCLK = 10 MHz			0.1	
I(LED)	Supply current	LED is turned off		0.8	1.6	mA
I(ANA)		LED is turned off		0.8	1.6	
I _{OH(S03)}		$V_{(Sn)} = 2.5 \text{ V}, R_{(IREF)} = 4200 \Omega$	-2.45	-3	-3.45	
IOH(S10)	Segment current	$V(Sn) = 2.5 \text{ V}, R(IREF) = 1260 \Omega$	-8.5	-10	-11.5	mA
IOH(S20)	Segment current	$V(Sn) = 2.5 \text{ V}, R(IREF) = 630 \Omega$	-17	-20	-23	
IOH(S30)		$V(Sn) = 2.5 \text{ V}, R(IREF) = 420 \Omega$	-25.5	-30	-34.5	
∆lOH(S)	Segment current error between bits	$V(LED) = 5 \text{ V}, R(IREF) = 630 \Omega, \ V(Sn) = 2.5 \text{ V}$		±3%	±6%	
VREF	Voltage reference		1.2	1.26	1.3	V

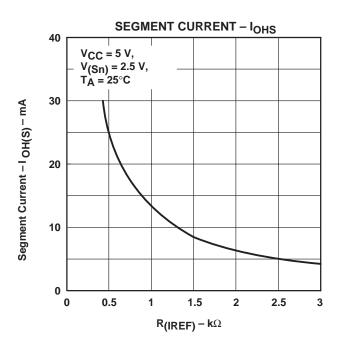
switching characteristics, $C_L = 15 pF$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	SOUT DSEL COMn Sn SOUT DSEL COMn Sn COMn COMn Sn COMn Sn COMn Sn COMn Sn COMn Sn COMn Sn COMn CO	SOUT			40	ns
		DSEL			40	
t _r		COMn			80	
				80		
		SOUT			40	
۱.,	Eall time	DSEL			40	ns
tf	raii ume	COMn			40	
		Sn			40	
	Propagation delay time	LATCH - Sn			40	ns
١		SCLK - Sn			40	
^t d		SCLK - SOUT			40	
		DSEL - DSEL			40	
	Propagation delay time	CSELn - COMn			120	ns
t(DLH)		DSEL - COMn			120	
		BLANK - COMn			120	
	Propagation delay time	CSELn - COMn			40	ns
t(DHL)		DSEL - COMn			40	
		BLANK - COMn			40	

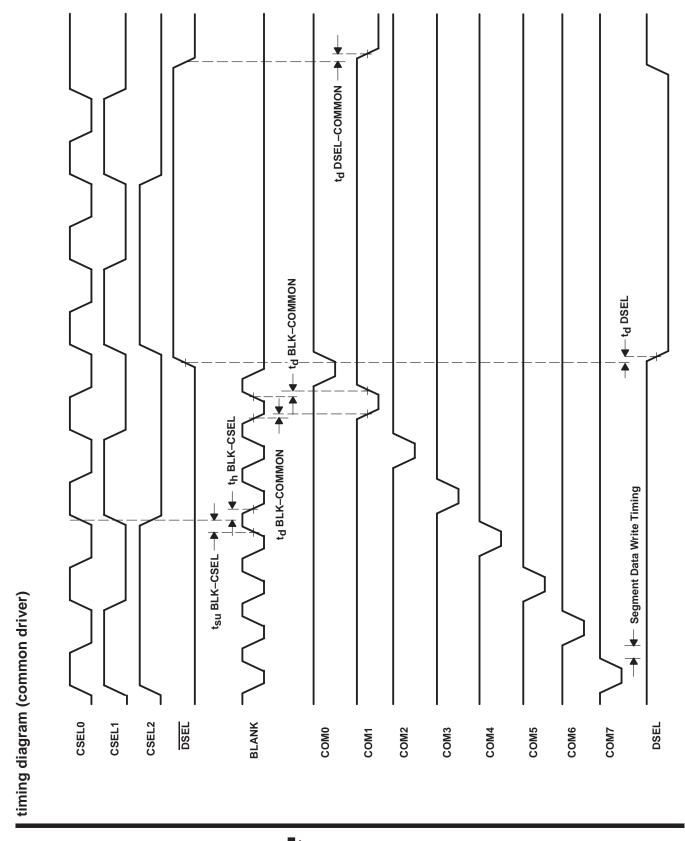
PARAMETER MEASUREMENT INFORMATION

POWER RATING



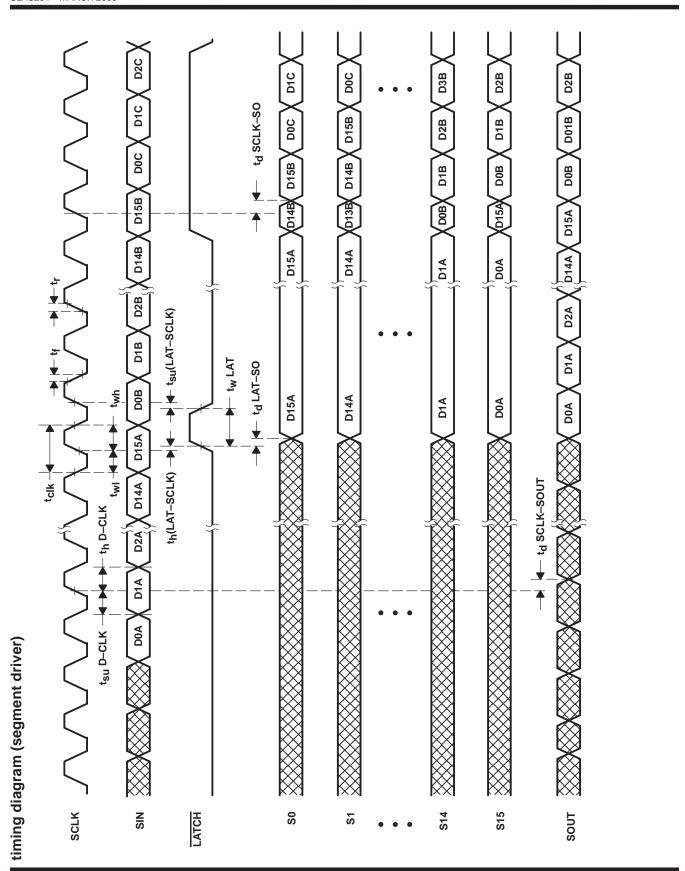


$$I_{OH(S)} = \frac{V_{REF}}{R_{(IREF)}} \times 10$$



TLC5920 16x8 BIT LED DRIVER/CONTROLLER

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APPLICATION INFORMATION

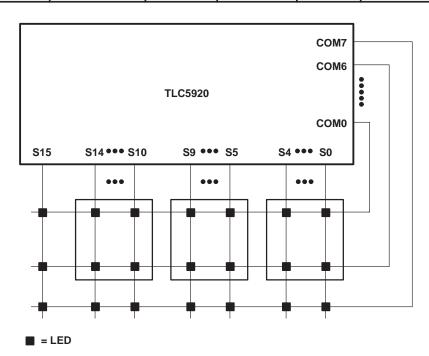
example 1

The other remaining terminals used for dot matrix LED drive can be utilized for LED lamp drive and other displays.

LEDs driven by TLC5920

cathode common type

LED			TLC5920	DUTY	DRIVE CURRENT	
TYPE	NO. OF COLOR	QUANTITY	QUANTITY	ווטם	(mA)	
LAMP	Mono	16	1	Static	30	
LAIVIP	Two	8	1	Static	30	
7 SEGMENT	Mono	16	1	1/8	30	
7 SEGIVIEINT	Two	8	1	1/8	30	
5 x 7	Mono	3	1	1/8	30	
5 X 7	Two	1	1	1/8	30	
8 x 8	Mono	2	1	1/8	30	
0 X O	Two	1	1	1/8	30	
	Mono	2	2	1/16	20	
16 x 16	Two	1	2	1/16	20	
	Three	1	3	1/16	13	
24 x 24	Mono	2	3	1/24	13	
	Two	1	3	1/24	13	

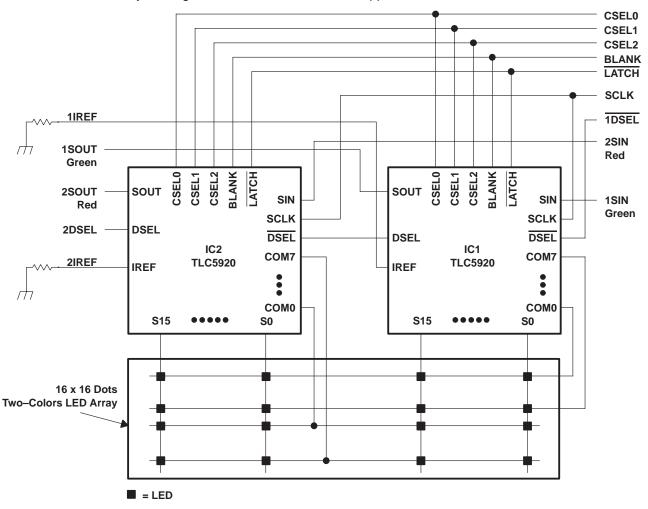




APPLICATION INFORMATION

example 2

Using two TLC5920s, an LED with two colors and 16 x 16 dots can be driven. The number of LED arrays can also be increased by making a cascade connection in the application circuit.



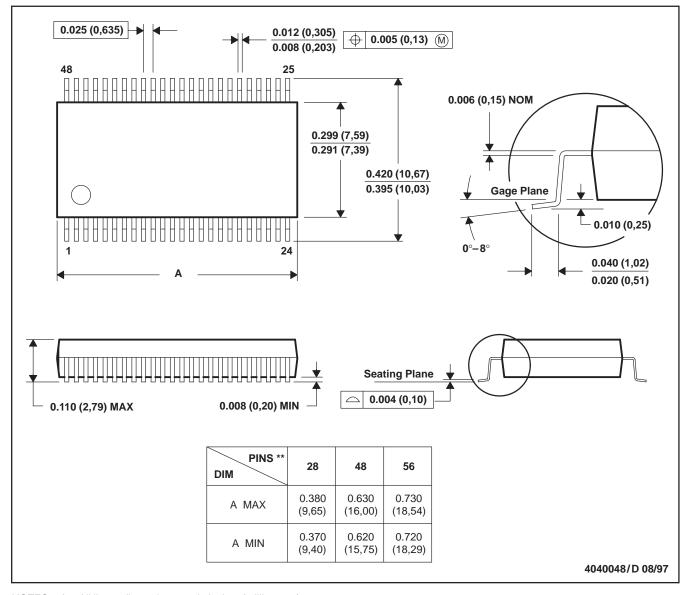


MECHANICAL DATA

DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118



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